

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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P-CHANNEL MOS FIELD EFFECT TRANSISTOR  
FOR SWITCHING

DESCRIPTION

The N0100P is a switching device, which can be driven directly by a 1.8 V power source.

This N0100P features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 1.8 V drive available
- Low on-state resistance  
 $R_{DS(on)1} = 44 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -2.0 \text{ A)}$   
 $R_{DS(on)2} = 56 \text{ m}\Omega \text{ MAX. (} V_{GS} = -3.0 \text{ V, } I_D = -2.0 \text{ A)}$   
 $R_{DS(on)3} = 62 \text{ m}\Omega \text{ MAX. (} V_{GS} = -2.5 \text{ V, } I_D = -2.0 \text{ A)}$   
 $R_{DS(on)4} = 105 \text{ m}\Omega \text{ MAX. (} V_{GS} = -1.8 \text{ V, } I_D = -1.5 \text{ A)}$
- Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
N0100P-T1-AT	Pure Sn (Tin)	Tape 3000 p/reel	SOT-23F

Marking: XX

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	-12	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	$\pm 8.0$	V
Drain Current (DC)	$I_{D(DC)}$	$\pm 3.5$	A
Drain Current (pulse) <sup>Note1</sup>	$I_{D(pulse)}$	$\pm 12$	A
Total Power Dissipation	$P_{T1}$	0.2	W
Total Power Dissipation <sup>Note2</sup>	$P_{T2}$	1.3	W
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

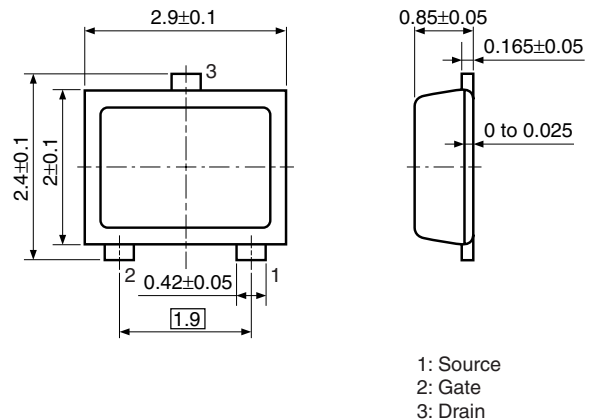
Notes 1.  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

2. Mounted on FR-4 board of 50 mm  $\times$  50 mm  $\times$  1.6 mm, copper foil 100%,  $t \leq 5 \text{ sec}$ .

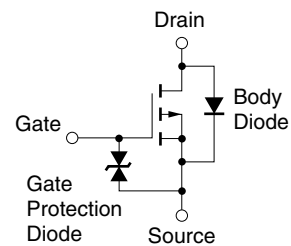
**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT

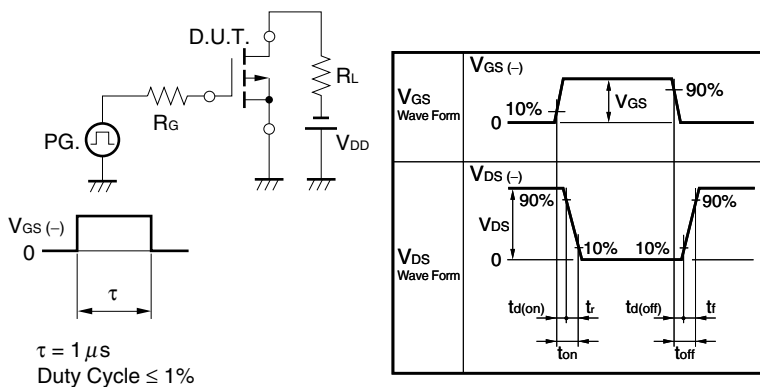


**ELECTRICAL CHARACTERISTICS (TA = 25°C)**

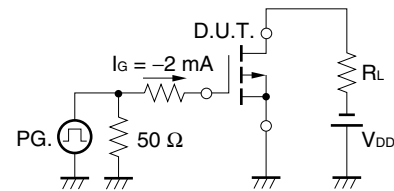
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -12\text{ V}, V_{GS} = 0\text{ V}$			-10	$\mu\text{A}$
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 8\text{ V}, V_{DS} = 0\text{ V}$			$\mp 10$	$\mu\text{A}$
Gate to Source Cut-off Voltage	$V_{GS(off)}$	$V_{DS} = -10\text{ V}, I_D = -1.0\text{ mA}$	-0.45		-1.5	V
Forward Transfer Admittance <sup>Note</sup>	$ y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -2.0\text{ A}$	4			S
Drain to Source On-state Resistance <sup>Note</sup>	$R_{DS(on)1}$	$V_{GS} = -4.5\text{ V}, I_D = -2.0\text{ A}$		37	44	$\text{m}\Omega$
	$R_{DS(on)2}$	$V_{GS} = -3.0\text{ V}, I_D = -2.0\text{ A}$		42	56	$\text{m}\Omega$
	$R_{DS(on)3}$	$V_{GS} = -2.5\text{ V}, I_D = -2.0\text{ A}$		46	62	$\text{m}\Omega$
	$R_{DS(on)4}$	$V_{GS} = -1.8\text{ V}, I_D = -1.5\text{ A}$		60	105	$\text{m}\Omega$
Input Capacitance	$C_{iss}$	$V_{DS} = -10\text{ V},$ $V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		720		pF
Output Capacitance	$C_{oss}$			150		pF
Reverse Transfer Capacitance	$C_{rss}$			80		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, I_D = -1.75\text{ A},$ $V_{GS} = -4.5\text{ V},$ $R_G = 10\ \Omega$		18		ns
Rise Time	$t_r$			37		ns
Turn-off Delay Time	$t_{d(off)}$			240		ns
Fall Time	$t_f$			114		ns
Total Gate Charge	$Q_G$	$V_{DD} = -10\text{ V},$ $V_{GS} = -4.5\text{ V},$ $I_D = -3.5\text{ A}$		8.3		nC
Gate to Source Charge	$Q_{GS}$			1.3		nC
Gate to Drain Charge	$Q_{GD}$			2.1		nC
Body Diode Forward Voltage <sup>Note</sup>	$V_{F(S-D)}$	$I_F = 3.5\text{ A}, V_{GS} = 0\text{ V}$		0.84		V
Reverse Recovery Time	$T_{rr}$	$I_F = 3.5\text{ A}, V_{GS} = 0\text{ V},$ $di/dt = 50\text{ A}/\mu\text{s}$		270		ns
Reverse Recovery Charge	$Q_{rr}$			300		nC

**Note** Pulsed

**TEST CIRCUIT 1 SWITCHING TIME**

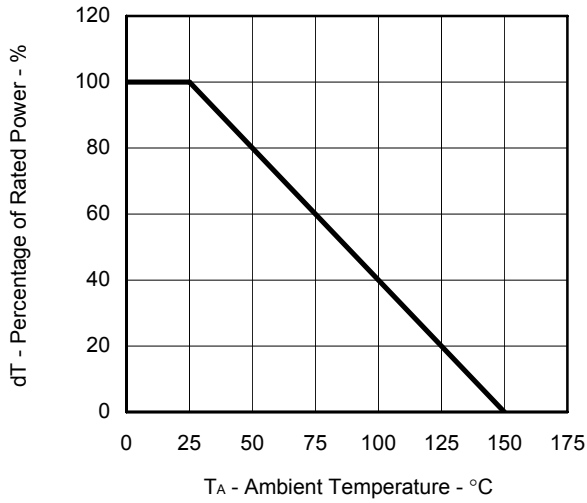


**TEST CIRCUIT 2 GATE CHARGE**

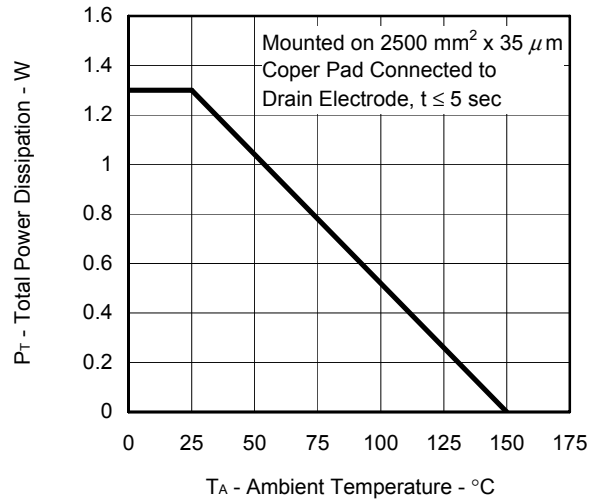


TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

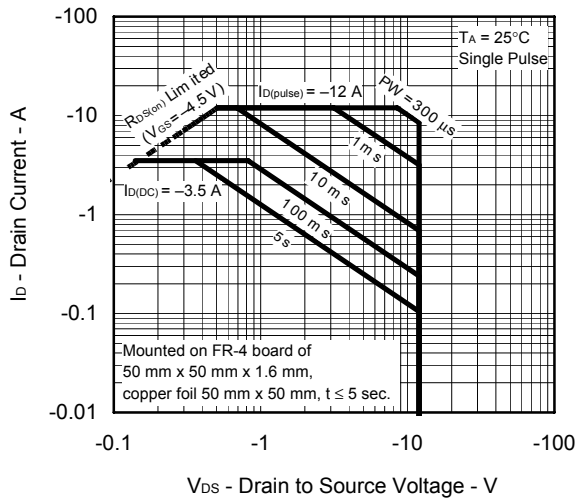
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



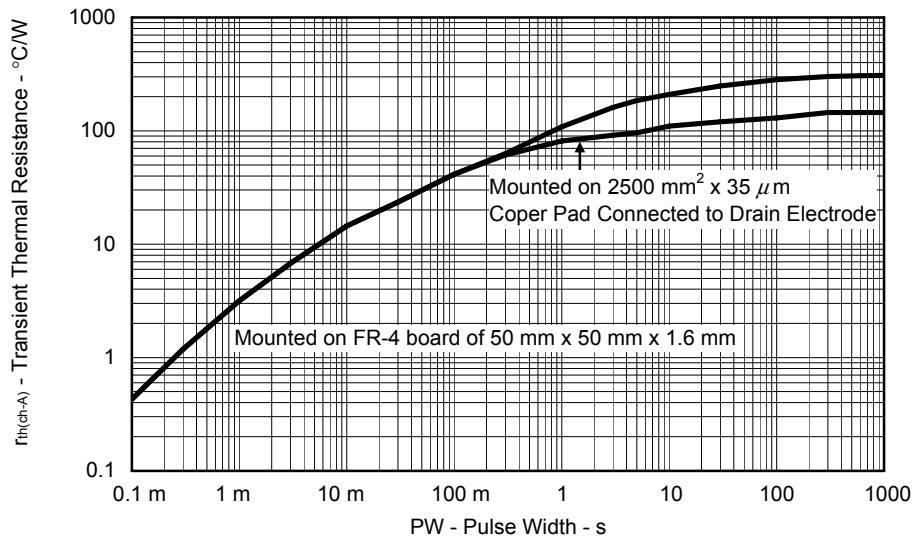
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



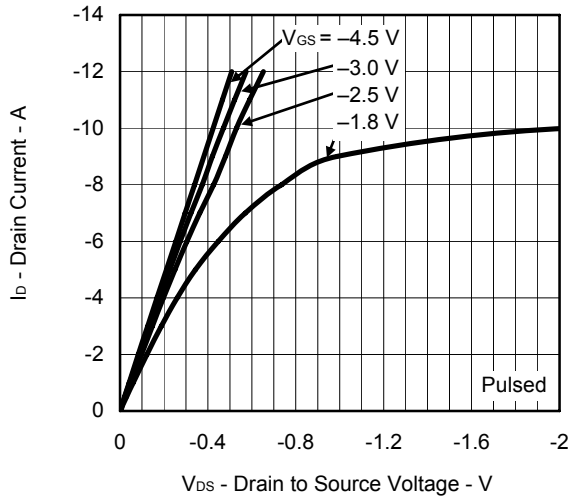
FORWARD BIAS SAFE OPERATING AREA



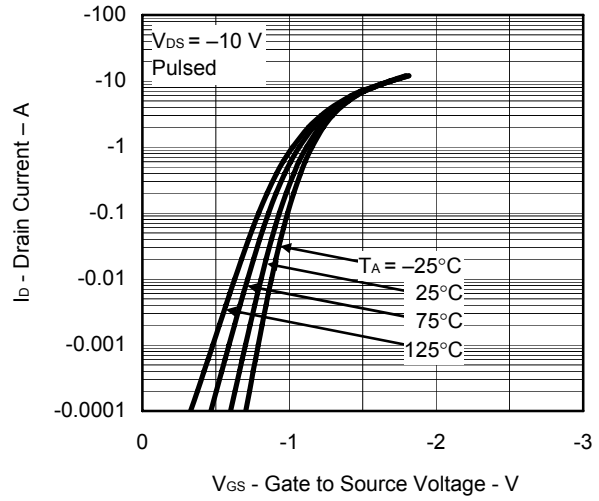
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



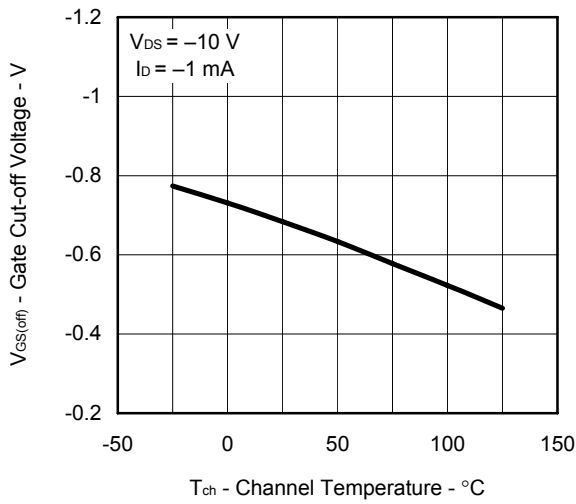
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



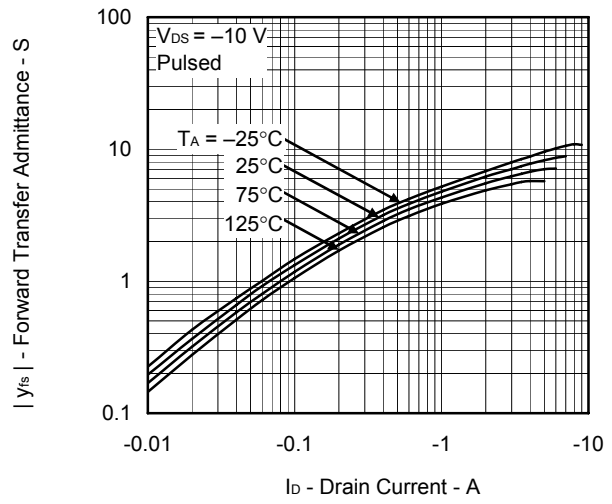
FORWARD TRANSFER CHARACTERISTICS



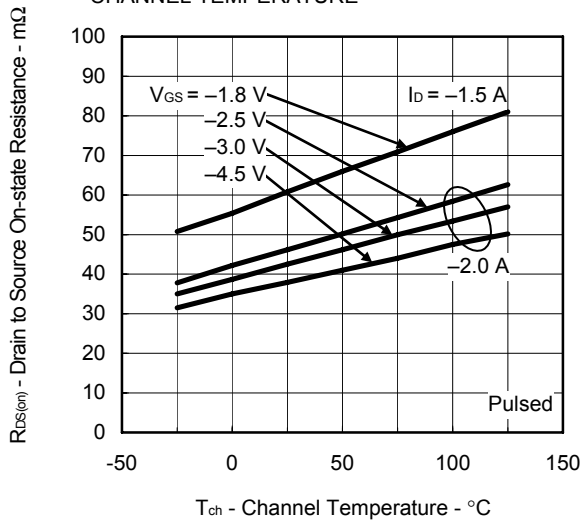
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



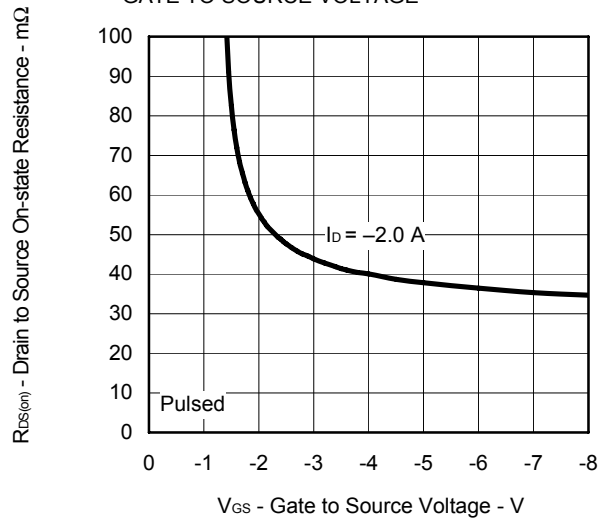
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



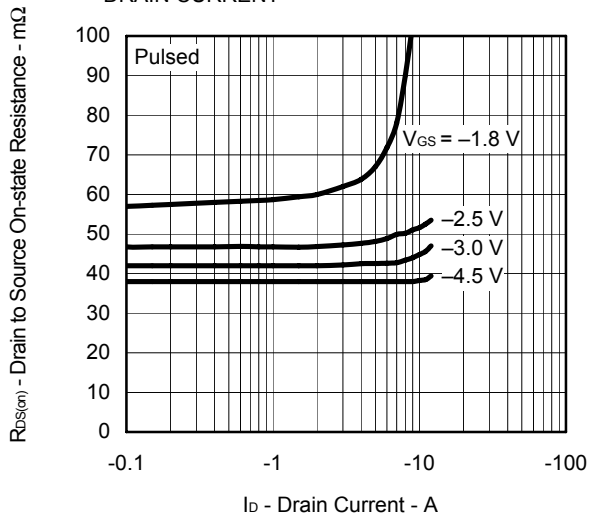
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



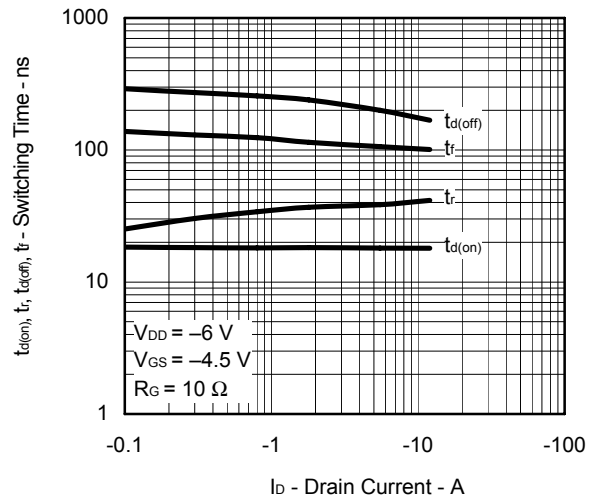
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



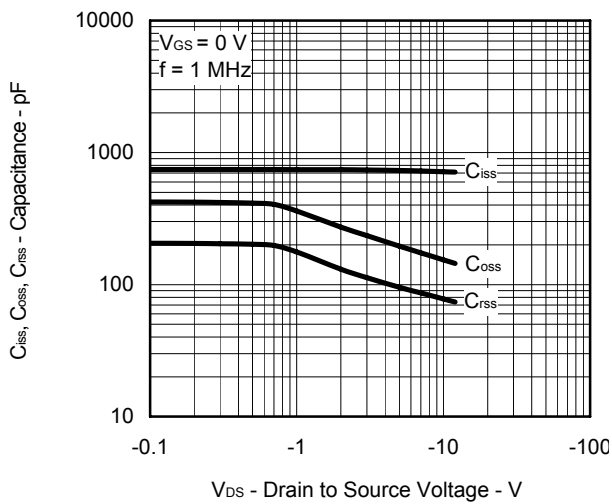
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



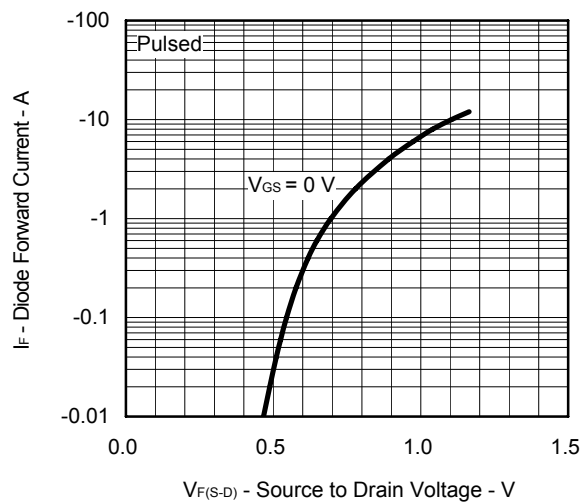
SWITCHING CHARACTERISTICS



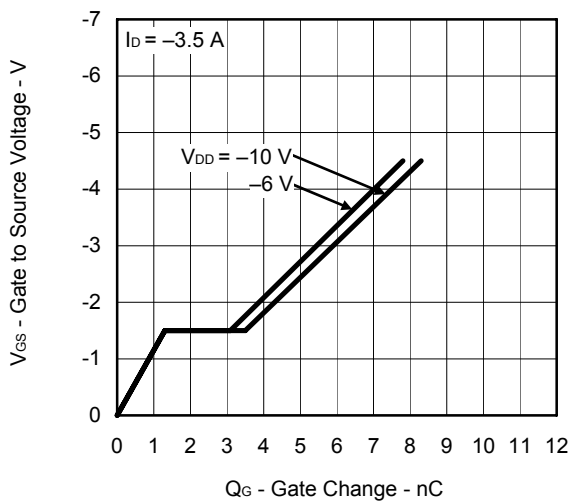
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



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